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Impedance and Admittance Measurements at Intercalated n-HfS\textsubscript{2}/Non-Aqueous Electrolyte Interface

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Hafnium disulfide, capacitance, impedance, admittance spectroscopy, copper intercalation.

Capacitance, impedance and admittance studies were performed on single crystal n-HfS\textsubscript{2} before and after copper intercalation from acetonitrile based electrolyte. The n-HfS\textsubscript{2}/non-aqueous electrolyte interface was modelled by equivalent R-C circuits containing frequency dependent elements. Electrochemical intercalation by copper into n-HfS\textsubscript{2} introduced Faradaic conductance effects. The composition of copper intercalated n-HfS\textsubscript{2} in close proximity to the interfacial region was obtained assuming a diffusion coefficient for copper in n-HfS\textsubscript{2} of \(10^{-5}\) cm\textsuperscript{2}/sec. The photo-anode demonstrated apparent degeneracy for > 0.1 moles of intercalated copper.
Impedance and admittance measurements at intercalated n-HfS$_2$/non-aqueous electrolyte interface

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Abstract

Capacitance, impedance and admittance studies were performed on single crystal n-HfS$_2$ before and after copper intercalation from acetonitrile based electrolyte. The n-HfS$_2$/non-aqueous electrolyte interface was modeled by equivalent R-C circuits containing frequency dependent elements. Electrochemical intercalation by copper into n-HfS$_2$ introduced Faradaic conductance effects. The composition of copper intercalated n-HfS$_2$ in close proximity to the interfacial region was obtained assuming a diffusion coefficient for copper in n-HfS$_2$ of $10^{-8}$ cm$^2$/sec. The photoanode demonstrated apparent degeneracy for $> 0.1$ moles of intercalated copper, suggesting that progressive electronic population of the n-HfS$_2$ conduction band was occurring. Capacitance values for intercalated n-HfS$_2$ were of the order $10^{-6}$ F/cm$^2$.

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Key words: Hafnium disulfide, copper intercalation, impedance, capacitance, admittance measurements
Group IVB transition metal dichalcogenides (TMDs) comprising HfS$_2$, HfSe$_2$, ZrS$_2$ and ZrSe$_2$ are interesting materials for photoelectrochemical (PEC) study since they can in principle function as both a photoelectrode and simultaneously as the substrate electroactive material for the reversible intercalation of transition metal species$^{1-13}$. For example, it has already been reported that ZrS$_2$ and HfS$_2$ are capable of maintaining their semiconducting properties after partial electrochemical intercalation by either Cu or Fe to form ZrM$_y$S$_2$ and HfM$_y$S$_2$ over the compositional range $0 < y < 0.22$.$^{13}$ Such intercalation does however result in a decrease of the band gap width. The group IVB TMDs have also been shown susceptible to cathodic intercalation by alkali and alkaline earth metals and organic species$^7$-$^{12}$. As expected, intercalation into these materials results in a widening of the van der Waals layers$^{14}$. Group IVB TMDs possess an octahedral structure with electron photoexcitation within the semiconductor band gap proceeding from energy bands derived from bonding sulfur p-orbitals into metal t$_2g$ d-orbitals$^6$. These photoelectrodes possess indirect band gaps with high absorption coefficients, since most incident photons become captured within 1000Å from the interfacial region$^{15}$.

Insight gained relating the dependency of photoelectrode properties for these materials on the presence or absence of intercalated metal species, will be of value for identifying conditions where they might be incorporated into PEC cells possessing in situ electrochemical energy storage. Work reported here applies impedance and admittance measurement techniques to single crystal n-HfS$_2$ materials in non-aqueous electrolyte, oriented parallel to the c-lattice vector $c$-$c$ where a high population of intercalation sites would be exposed. Measurements were performed on this photoanode before and after electrochemical intercalation by copper which allowed us to preliminarily model the interfacial section. From such information liquid non-aqueous electrolyte and solid polymer electrolyte PEC storage cells using this photoanode might be more systematically prepared.

**EXPERIMENTAL**

Single crystals of n-HfS$_2$ were prepared by the halogen (I$_2$) vapor transport technique (Northwestern University). Initial solid-state chemical reaction between Hf (99.9%) and S (99.999%) was accomplished by heating an intimate mixture together with 5mg I$_2$/ml of the quartz transport tube volume. This was performed in a three temperature zone furnace. Typical thermal gradients used
were between 875°C and 800°C. Crystal growth occurred over 25 days. In all cases the relatively large crystals obtained were intrinsically n-type. Ohmic contact to n-HfS$_2$ was accomplished by sparking indium onto one side of the crystal using a 15 volt DC power supply. This was performed using a fine indium wire as a cathode with the other pole of the power supply clamped to the n-HfS$_2$ single crystal. When the indium wire was within ±1mm of the crystal, a transient spark could be observed. This resulted in ion implantation of indium into the ohmic contact region. Current collection was performed with a nichrome wire attached with silver epoxy and cured at 120°C for 1h. Photoelectrodes were then appropriately isolated from later contact with the electrolyte by epoxy (Norton Chemplast), so that only the single crystal front face of interest was exposed. Typical photoelectrode areas for H-c oriented crystals were 0.06cm$^2$.

Measurements were performed in a standard glass H-cell arrangement using a platinum counter electrode. SCE was used as a reference to the working electrode compartment via a salt bridge. Photoelectrode potentials were controlled by a Stonehart Associates BC 1200 potentiostat. Impedance, conductance and capacitance measurements were performed using a Hewlett-Packard 4276A digital LCZ meter over the frequency range 20kHz-100Hz.

RESULTS AND DISCUSSION

Work performed was directed towards investigating the interfacial characteristics of single crystal n-HfS$_2$ in liquid non-aqueous electrolyte (acetonitrile containing 0.1M tetrabutylammonium hexafluorophosphate (TBAPF$_6$) as the supporting electrolyte) in the presence of 0.001M CuCl, both with and without copper intercalation. From capacitance, impedance and admittance measurements the interfacial behavior could be modelled by an equivalent circuit which incorporated frequency dependent resistances, R$_V$, capacitances, C$_V$, together with the mobile space charge capacitance, C$_{SC}$ and the cell resistance R$_e$.

The presence of frequency dependent elements may originate from a variety of charge accumulation modes such as surface states caused by adsorption, inhomogeneous doping and crystal defects. Expressions for the total admittance Y, impedance Z, conductance G, and susceptance B, for an equivalent circuit consisting of a large number of R-C elements, could be represented by the following relationships$^{16,17}$:

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\[ Y = a \omega^n + k \omega^n \]  \hspace{1cm} (1) \\
\[ Z = A \omega^{-n} - jB \omega^{-n} \]  \hspace{1cm} (2) \\
\[ G = a \omega^n \]  \hspace{1cm} (3) \\
\[ B = b \omega^n \]  \hspace{1cm} (4)

where \( A, B, a, b \) and \( n \) are characteristic circuit constants and \( \omega \) is the angular frequency.

Impedance and admittance responses for \( II-c \)-oriented \( n\text{-HfS}_2/\text{acetonitrile} \) interface were performed over the frequency range 20kHz to 100Hz in the dark. The impedance and admittance results for this interfacial region in the absence of any copper intercalation within the \( n\text{-HfS}_2 \) or copper present in the electrolyte are shown respectively in Figures 1 and 2. The dark photoelectrode possessed an initial open-circuit potential (OCP) of \(-0.295\)V vs. SCE. The impedance data (Figure 1) could be approximated by two linear regions corresponding to high and low frequencies. From our previously reported work\(^{18}\) on \( \text{-c} \)-oriented \( n\text{-HfS}_2 \), linear dependencies were found between real and imaginary impedance over this whole frequency range for dark photoelectrode possessing an OCP at \(-0.103\)V, however at \(-0.253\)V two linear regions were observed, analogous to the result obtained here. A change in dependence between real and imaginary parts of the cell impedance with frequency, as in Figure 1, suggested a complex equivalent circuit for the interfacial region in which the impedance response of one part predominates at low and another part at higher frequencies. From this data the cell resistance (\( R_{\text{el}} \)) was obtained by extrapolating the high frequency impedance data to infinite frequency giving \( R_{\text{el}} = 165\Omega \).

The admittance data shown in Figure 2 gave a semicircular plot possessing a radius of \( 6 \times 10^{-4} \, \text{1/\Omega} \), equivalent to \( 1/R_{\text{el}} \). No additional semicircular regions were observed indicating a different frequency dependence of admittance at high and low frequencies. Therefore, if the \( n\text{-HfS}_2 \) interfacial region could be represented by one general equivalent circuit acting as two separate circuits responsive to respectively high and low frequency regions, their time constants must be similar.\(^{19,20}\) Impedance and admittance responses for the \( II-c \)-oriented \( n\text{-HfS}_2 \) interface can be explained by the equivalent circuits shown in Figure 3a. In this figure \( C_{\text{sc}} \) represents a frequency independent capacitance attributed to the photoanode space charge capacitance while \( C_V \) and \( R_V \) represent the frequency dependent capacitance and resistance, respectively, operating in high
and low frequency regions. The magnitude of $C_{sc}$ is usually relatively small compared to $C_v$ and in the low frequency region its contribution can be neglected. The network operating at higher frequencies (A) accounts for the linear impedance response observed above 1kHz, crossing the real impedance axis at $R_{el}$ (Figure 1) as well as for a semicircular admittance response of radius $1/R_{el}$ (Figure 2). Another network (B) accounts for a change in impedance slope at frequencies below 1kHz and appears to possess a semicircular response analogous to that found at high frequencies. Upon introducing 0.001M CuCl into the above cell, the dark n-HfS$_2$ OCP changed from -0.295V to -0.11V vs. SCE. Copper intercalation proceeded into the n-HfS$_2$ by potentiostatting the electrode at -0.26V vs. SCE when a steady-state cathodic current of the order of $\pm 10\mu$A occurred. The cathodic electrochemical intercalation of n-HfS$_2$ by copper could proceed in the dark since the necessary electrons are present as majority carriers. Impedance and admittance data were obtained after respectively 42 min. and 129 min. after initiating intercalation (Figures 4 and 5). Assuming a diffusion coefficient for copper intercalation of $D = 10^{-8}$cm$^2$/sec, then a mean intercalation depth $X$ given by equation (5) can be calculated:

$$X = \sqrt{2Dt}$$

and the respective degree of intercalation to this depth $X$ after 42 and 129 min. would correspond to the stoichiometries HfCu$_0.18$S$_2$ and HfCu$_0.3$S$_2$. The impedance data obtained (Figures 4 and 6) approximated a linear relationship between real and imaginary parts in the low frequency region with a circular dependence being observed at higher frequencies. This latter observation suggested an additional resistive element in parallel to the variable resistance of the network operating in the high frequency region shown in Figure 3a. A value for this new resistance $R_0$ was estimated on the basis of the semicircular radius drawn through experimental data in this high frequency region. For n-HfS$_2$ copper intercalated for 42 min. $R_0$ was found to be of the order $\approx 2000\Omega$. Such resistance was not found in the absence of copper intercalation suggesting that $R_0$ may represent resistance for reversible intercalation by copper in n-HfS$_2$.

At measurement frequencies below 1kHz the imaginary part of the cell impedance was found to decrease by an order of magnitude after initial copper intercalation and progressively decreased upon further intercalation as shown by reference to Figures 1, 4 and 6. This observation suggested an increased capacitive cell response in the low frequency region attributable to the presence of intercalated..
copper. Similar conclusions could also be drawn from the admittance data shown in Figures 2, 5 and 7. For measurement frequencies below ~1kHz copper intercalated n-HfS$_2$ showed higher susceptance values (Figures 5, 7) compared to when copper was absent (Figure 2). This suggests the presence of a capacitive element associated with Faradaic copper intercalation $C_o$, in series with $R_o$ in this lower frequency range.

Admittance data obtained after respectively 42 and 129 min. of copper intercalation demonstrated a semicircular response in both the low and high frequency region as shown respectively in Figure 5 and 7. This observation may be attributable to differences in time constants for predominant circuit elements operating in high and low frequency ranges for copper intercalated n-HfS$_2$. The overall impedance and admittance response experimentally observed for copper intercalated n-HfS$_2$ in acetonitrile could be modelled by the equivalent circuits shown in Figure 3b. This circuit combines all the network elements explaining experimental observations in the high and low frequency regions. In these equivalent circuits the capacitance element $C_o$ associated with reversible copper intercalation may be omitted in the high frequency region, whereas n-HfS$_2$ space charge capacitance $C_{sc}$ may be eliminated at lower frequencies.

To investigate the influence of intercalated copper on n-HfS$_2$ $C_{sc}$ in acetonitrile, impedance and admittance responses were analyzed as previously described by others$^{16,17}$. $C_{sc}$ for $\| c$ oriented n-HfS$_2$ in acetonitrile was obtained by subtracting susceptance values associated with cell resistance, $R_{el}$, from measured susceptance and by extrapolating capacitance data to infinite frequency (Figure 8). A value for $C_{sc}$ of $\approx 3.2 \times 10^{-7}$ F/cm$^2$ at -0.295V vs. SCE was obtained, higher than $2.5 \times 10^{-7}$ F/cm$^2$ at -0.103V vs. SCE determined in a previous study$^{18}$ by us using similar single crystal material, as expected at the more negative electrode potential used here. The dark $C_{sc}$ for n-HfS$_2$ increased to $1.4 \times 10^{-6}$ F/cm$^2$ after intercalating copper at -0.26V vs. SCE and remained essentially constant during the intervening (129 min.) intercalation (Figure 9). The potential of the dark n-HfS$_2$ electrode after 10-129 min. intercalation was relatively constant and remained at $\approx$-0.1V vs. SCE during 129 min. of intercalation. This suggested an equilibrium concentration of intercalated copper present after about 10 min. with further intercalation resulting in deeper copper incorporation into the crystal structure. For longer copper deposition times than 129 min. unit activity copper was evident on the n-HfS$_2$ surface after which the OCP became -0.4V vs. SCE. Cyclic
voltammograms for copper intercalated n-HfS\textsubscript{2} in acetonitrile are shown in Figure 10. The current peak corresponding to the reversible intercalation of copper was found to increase somewhat with time as the degree of copper intercalation was increased. Again this suggested that the semiconductor surface came relatively quickly to equilibrium (within \(\approx 10\) min.) in the concentration of intercalated copper. For single crystal n-HfS\textsubscript{2} used in this work the initial photopotential obtained prior to intercalation was 217mV under 100mW/cm\textsuperscript{2} ELH illumination, but was found to decrease to 55mV upon initial copper intercalation, 20mV after 5 min. at \(\approx 10\mu A\) and 18mV after 10 min. No photopotential was observed after 42 min.

To gain further insight into the influence of intercalated copper on the behavior of n-HfS\textsubscript{2} admittance spectroscopy analysis of the admittance data was performed\textsuperscript{21,22}. Results of this analysis are summarized in Figure 11. In the simplest case the n-HfS\textsubscript{2}/electrolyte interface was assumed to consist of the space charge capacitance, \(C_{SC}\), connected in series with a bulk conductance \(G_{el}\). By comparing real and imaginary parts of the admittance equation for such an equivalent circuit, with the appropriate in-phase admittance components being obtained experimentally, the following relationship can be obtained:

\[
\frac{G}{\omega} = \frac{\omega C_{SC}^2 G_{el}}{G_{el}^2 + (\omega C_{SC})^2}
\]

where \(\omega\) represents the measured in-phase cell conductance. By plotting \(G/\omega\) vs. \(\omega\) a maximum was given at

\[
\frac{G}{\omega_{\text{max}}} = C_{SC}/2
\]

from which the space charge capacitance was determined. The peak \(G/\omega\) (where \(\omega\) corresponds to the total cell conductance) was identified with the n-HfS\textsubscript{2} space charge capacitance (curve A). Upon introducing CuCl into the electrolyte (curves B-D) evidence for an additional parameter in the equivalent circuit became evident. This was interpreted as corresponding to a Faradaic conductance in parallel to \(C_{SC}\) as shown by a linear log \(G/\omega\) vs. log \(\omega\) relationship\textsuperscript{1,22}. At sufficiently low frequencies the measured conductance became equal to the Faradaic conductance. Thus, increased conductance in the low/middle frequency region for copper intercalated HfS\textsubscript{2} gave evidence for the Faradaic intercalation-deintercalation reaction of copper. Unfortunately, increased conductance by the cell due to electron transfer at the interface...
overshadows effects from the space charge capacitance. Deposition of copper onto the n-HfS$_2$ surface (curve E) shifted the conductance associated with the Faradaic reaction to even higher values. This suggested a higher exchange current density for this copper compared to that intercalated within the n-HfS$_2$.

It has been suggested that metals intercalated into group IVB TMDs result in the formation of energy levels within the band gap$^7$. Copper deintercalation from voltammetric experiments occur even in the absence of any measurable photopotential suggesting the formation of energy levels close to the conduction band during intercalation. A similar explanation has been postulated$^{23}$ for cyclopropenamine intercalated HfSe$_2$. Intercalation by copper or iron into HfS$_2$ and HfSe$_2$ by others$^{13}$ has indicated that the electrode remains semiconducting at intercalation levels below HfCu$_0.22$S$_2$. It is probable that in work discussed here the degree of copper intercalation may have been higher than calculated using the diffusion coefficient $10^{-8}$cm$^2$/sec. To preserve n-HfS$_2$ semiconducting properties the total charge passed during copper intercalation should be lower than 0.3C per 1cm$^2$ for n-c oriented material. Such intercalating photoelectrodes may eventually be of interest in liquid non-aqueous or solid polymer electrolyte cells. In the latter cells the deintercalated transition metal ions would be stored in close proximity to the electrode/solid electrolyte interfacial region.

CONCLUSION

The n-c oriented n-HfS$_2$/non-aqueous electrolyte interface can be modelled by equivalent circuits consisting of space charge capacitance, cell resistance and frequency dependent R-C elements. In the presence of intercalated copper in n-HfS$_2$ increased Faradaic conduction became evident related to intercalation-deintercalation at the interfacial region. The space charge capacitance of n-HfS$_2$ in acetonitrile was obtained by eliminating the capacitive response of frequency dependent elements and was found to be of the order $10^{-7}$ F/cm$^2$. This increased to $10^{-6}$ F/cm$^2$ after intercalating $> 18\%$ copper into this semiconductor. Electrochemical copper deintercalation proceeded in the dark suggesting that the semiconductor became degenerate at this degree of intercalation with a high population of electrons being localized close to the n-HfS$_2$ conduction band.

ACKNOWLEDGEMENT

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REFERENCES

FIGURE CAPTIONS

Figure 1. Impedance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\)) at OCP (-0.295V).

Figure 2. Admittance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\)) at OCP (-0.295V).

Figure 3a. Equivalent circuits for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\)) at high (A) and low (B) frequencies.

Figure 3b. Equivalent circuit for copper intercalated \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) at high (A) and low (B) frequencies.

Figure 4. Impedance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after 42 minutes copper intercalation (±10μA) at -0.26V vs. SCE.

Figure 5. Admittance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after 42 minutes copper intercalation (±10μA) at -0.26V vs. SCE.

Figure 6. Impedance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after 129 minutes copper intercalation (±10μA) at -0.26V vs. SCE.

Figure 7. Admittance response for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after 129 minutes copper intercalation (±10μA) at -0.26V vs. SCE.

Figure 8. Frequency dependent capacitance for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\)) at OCP (-0.295 vs. SCE). Geometric electrode area 0.06cm\(^2\).

Figure 9. Frequency dependent capacitance for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after copper intercalation at -0.26V vs. SCE (±10μA) for 10 minutes (curve A), 42 minutes (curve B) and 129 minutes (curve C). Geometric electrode area 0.06cm\(^2\).

Figure 10. Cyclic voltammograms for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\) + 0.001M CuCl) after copper intercalation of -0.26V (±10μA) for A) 2 min., B) 5 min., and C) 10 min. Scan rate: 20mV/sec.

Figure 11. Relationship between \(G/\omega\) and \(\omega\) for \(n\)-c oriented \(n\)-HfS\(_2\) in CH\(_3\)CN (0.1M TBAPF\(_6\)) without (curve A) and with (curves B-E) 0.001M CuCl. Curve A at OCP -0.295V vs. SCE. Curves B, C and E after 10, 42 and 129 minutes respectively copper intercalation at -0.26V (±10μA) (OCP -0.1V); E after 130 minutes when copper deposition on the \(n\)-HfS\(_2\) surface became evident (OCP -0.4V vs. SCE).

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Figure 1: Impedance response for H-c oriented n-HfS$_2$ in CH$_3$CN (0.1 M TKAPF$_6$) at OCP (-0.295V).
Figure 2. Admittance response for H-c oriented n-HfS2 in CH3CN (0.1M TAPF6) at OCP (-0.295V).
Figure 3a. Equivalent circuits for n-c oriented n-HfS2 in CH₃CN (0.1M TBAPF₆) at high (A) and low (B) frequencies.
Figure 3b. Equivalent circuit for copper intercalated Li-C oriented n-HF$_2$ in CH$_3$CN (0.1M TBAPF$_6$ + 0.001M CaCl$_2$) at high (A) and low (B) frequencies.
Figure 4. Impedance response for n-c oriented n-HfS$_2$ in CH$_3$CN (0.1M TBAPF$_6$ + 0.001M CuCl) after 42 minutes copper intercalation (±10μA) at -0.26V vs. SCE.
Figure 5. Admittance response for II-c oriented n-HfS₂ in CH₃CN (0.1 M HAPF₆ + 0.001M CuCl) after 42 minutes copper intercalation (±10μA) at -0.26V vs. SCE.
Figure 12: Impedance response for n-type oriented n-HfS2 in CH3CN

20kHz

1kHz

2kHz

Zr (Ω)

250

500

750

1000

-200

-400

1000
Figure 7. Admittance response for H-c oriented n-HfS$_2$ in CH$_3$CN in TBA PF$_6$ + 0.001M CuCl$_2$ after 129 minutes copper intercalation (at 10$\mu$A) at -0.26V vs. SCE.
Dependent capacitance for n-c oriented n-HfS₂ in CH₃CN

Experimental data: -0.298 vs. SCE. Geometric electrode area.
Figure 9. Frequency dependent capacitance for n-c oriented n-HfS$_2$ in CH$_3$CN (0.1M TBAPF$_6$ + 0.001M CuCl) after copper intercalation at -0.26V vs. SCE (+10µA) for 10 minutes (curve A), 42 minutes (curve B) and 129 minutes (curve C). Geometric electrode area 0.06cm$^2$. 
Figure 10. Cyclic voltammograms for II-c oriented n-HfS₂ in CH₃CN (0.1M TBAPF₆ + 0.001M CuCl) after copper intercalation of -0.26V (±10µA) for A) 2 min., B) 5 min., and C) 10 min. Scan rate: 20mV/sec.
Figure 11. Relationship between $G/\omega$ and $\omega$ for II-c oriented $n$-HfS$_2$ in CH$_3$CN (0.1M TBAPF$_6$) without (curve A) and with (curves B-E) 0.001M CuCl. Curve A at OCP -0.295V vs. SCE. Curves B, C and D after 10, 42 and 1214 minutes respectively copper intercalation at -0.26V (±10μA) (OCP -0.1V); E after 130 minutes when copper deposition on the HfS$_2$ surface became evident (OCP -0.4V vs. SCE).

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